

/ Descriptions

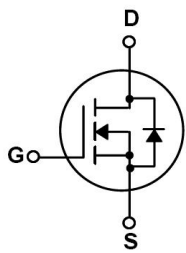
/ Features

1. 1

/ Applications

DC/DC

/ Equivalent Circuit



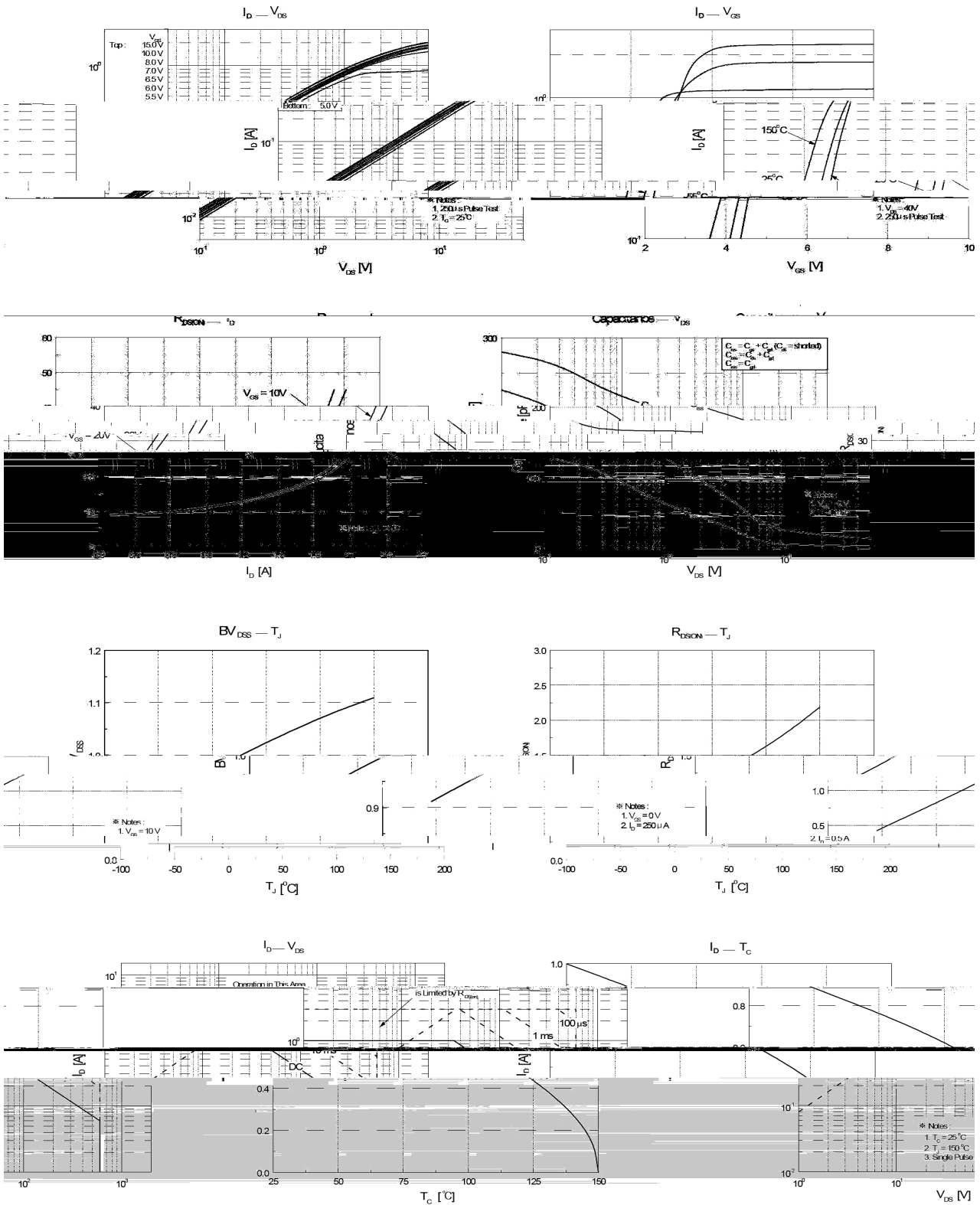
/ Pinning



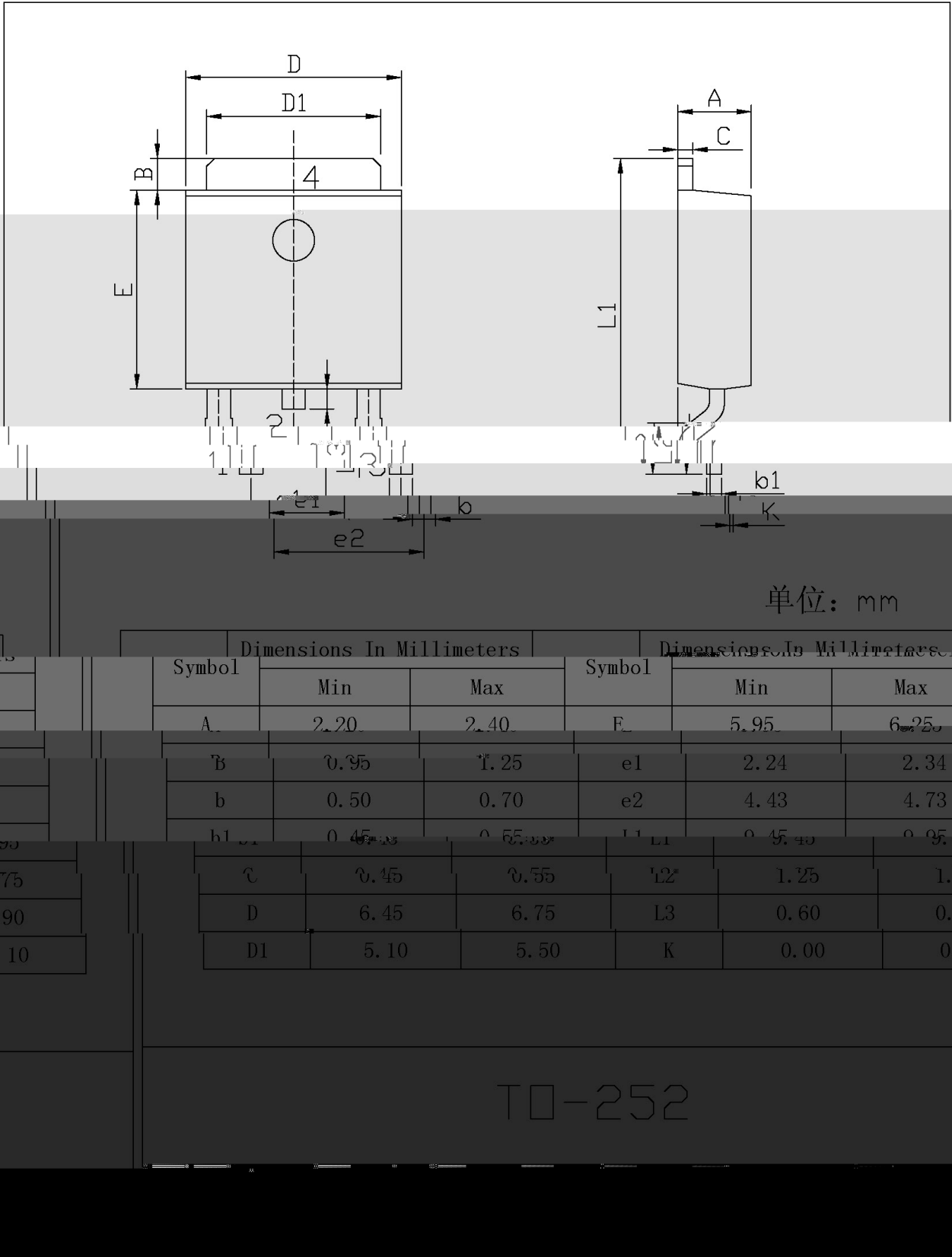
/ h_{FE} Classifications & Marking

[illegible]

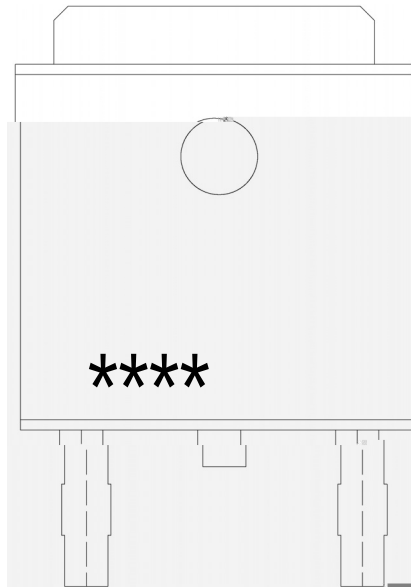
/ Electrical Characteristic Curve



/ Package Dimensions

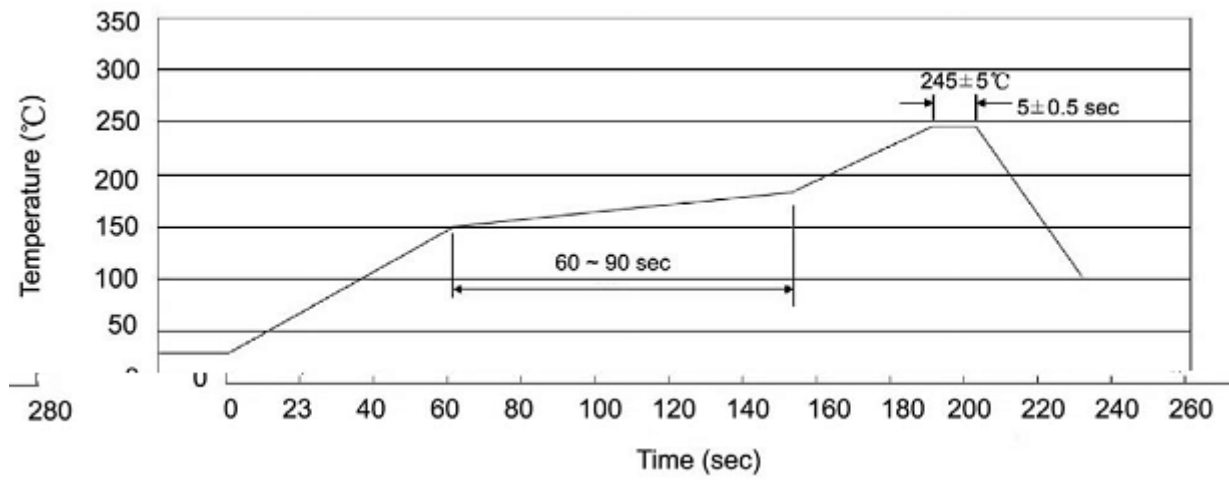


/ Marking Instructions



1N60

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
TO-252	2,500	2	5,000	5	25,000	13 ×16	360×360×50	385×257×392